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RF3861

WIDE BANDWIDTH, HIGH LINEARITY LOW NOISE AMPLIFIER

Package Style: QFN, 16-Pin, 3mmx3mm



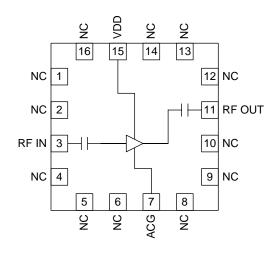


Features

- Low Noise and High Intercept Point
- Adjustable Bias for Enhanced IP3
- Single 2.5V to 6.0V Power Supply
- 400 MHz to 3800 MHz Operation
- QFN16, 3mmx3mm Package

Applications

- GSM/EDGE, CDMA, PCS, UMTS LNA/Linear Driver
- WLAN LNA/Linear Driver
- WiMAX LNA/Linear Driver
- 900 MHz LNA/Linear Driver
- General Purpose Amplification



Functional Block Diagram

Product Description

The RF3861 is a low noise amplifier with a high output IP3. The amplifier is self-biased from a single voltage supply with 50 Ω input and output ports. The useful frequency range is from 400MHz to 3800MHz. A 1dB noise figure and 36dBm OIP3 performance is achieved with a 5V V_{DD}, 90mA. Current can be increased to raise OIP3 while having minimal effect on noise figure. The IC is featured in a standard QFN, 16-pin, 3mmx3mm package.

Ordering Information

RF3861 Wide Bandwidth, High Linearity Low Noise Amplifier RF3861PCK-410 Fully Assembled Evaluation Board with 5 Sample Parts

1.5 GHz to 2.7 GHz

Optimum Technology Matching® Applied

☐ GaAs HBT	☐ SiGe BiCMOS	▼ GaAs pHEMT	☐ GaN HEMT
☐ GaAs MESFET	☐ Si BiCMOS	☐ Si CMOS	☐ RF MEMS
☐ InGaP HBT	☐ SiGe HBT	☐ Si BJT	☐ LDMOS

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Absolute Maximum Ratings

Parameter	Rating	Unit
Supply Voltage	6V	V _{DC}
Input RF Level	+10	dBm
Current Drain, I _{DD}	150	mA
Operating Ambient Temperature	-40 to +85	°C
Storage Temperature	-40 to +150	°C

Note 1: Max continuous RF IN is $\pm 10\,\mathrm{dBm}$. The max transient RF IN is $\pm 20\,\mathrm{dBm}$.



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

RoHS status based on EUDirective 2002/95/EC (at time of this document revision).

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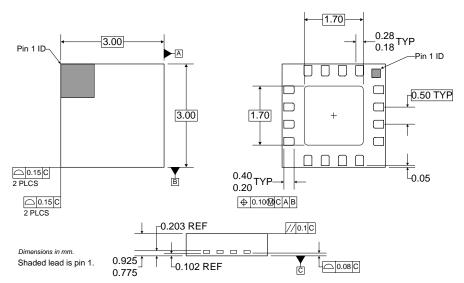
Paramatar		Specification		Unit	Condition	
Parameter	Min.	Тур.	Max.	Unit	Condition	
High Band						
Frequency	3.3	3.5	3.8	GHz	V _{DD} =5V	
Current		90	110	mA		
Gain		10		dB	At 3.5 GHz	
Noise Figure		1.1		dB	+25°C, V _{DD} =5V, I _{DD} =90mA, 3500MHz unless specified	
OIP3		37.0		dBm		
OP1dB		22.0		dBm		
S11		-12		dB	f ₁ =3500MHz, f ₂ =3501MHz	
S22		-18		dB		
Mid Band						
Frequency	1500		2700	MHz		
Current		90	110	mA	V _{DD} =5V	
Gain	13.5	14.5	16.5	dB	+25°C, V _{DD} =5V, I _{DD} =90mA, 2000MHz unless specified	
Noise Figure		1.0	1.2	dB		
OIP3	33.0	35.5		dBm	f ₁ =2000MHz, f ₂ =2001MHz	
OP1dB	21.0	22.5	25.0	dBm		
S11		-10		dB		
S22		-20		dB		
Low Band						
Frequency	700		1100	MHz		
Current		90	110	mA	V _{DD} =5V	
Gain		16		dB	+25°C, V _{DD} =5V, I _{DD} =90mA, 850MHz unless specified	
Noise Figure		1.2		dB		
OIP3		36.0		dBm	f ₁ =850MHz, f ₂ =851MHz	
OP1dB		22.5		dBm		
S11		-14		dB		
S22		-18		dB		
Thermal						
Theta _{JC}		51		°C/W		
Power Supply						
Device Operating Voltage	2.5	5.0	6.0	V		
Operating Current	65	90	110	mA	V _{DD} =5.0V, R2=open	



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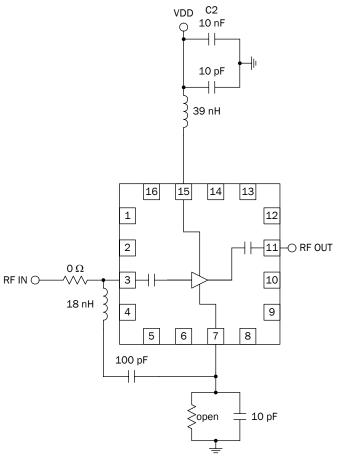
Pin	Function	Description	Interface Schematic
1	NC	Not connected.	
2	NC	Not connected.	
3	RF IN	RF input pin. 50Ω matched. This pin is DC-blocked.	
4	NC	Not connected.	
5	NC	Not connected.	
6	NC	Not connected.	
7	ACG	AC ground. Shunt cap may be added for tuning. Shunt resistor may be added to increase I _{DD} /IP3.	
8	NC	Not connected.	
9	NC	Not connected.	
10	NC	Not connected.	
11	RF OUT	RF output pin. 50Ω matched. This pin is DC-blocked.	
12	NC	Not connected.	
13	NC	Not connected.	
14	NC	Not connected.	
15	VD	Bias voltage. 2.5V to 6.0V applied through bias inductor.	
16	NC	Not connected.	
Pkg Base	GND	Ground connection.	

Package Drawing





Application Schematic 400 MHz to 1300 MHz

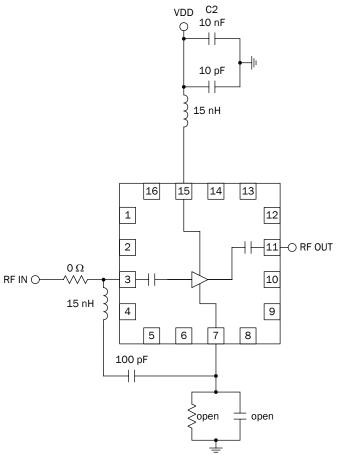


FREQ	VCC	NF	GAIN	OIP3	OP1dB
MHz	Volts	dB	dB	dBm	dBm
400	5	1.7	15.23	35.45	21.27
600	5	1.4	15.81	37.33	21.84
800	5	1.2	16.49	36.56	22.05
1000	5	1.1	16.7	36.22	22.02
1300	5	1.1	15.28	36.88	22.19

Note: This schematic is equivalent to standard 700 MHz to 1100 MHz evaluation board. Specification in above table shows tested performance over extended frequency range. See Theory of Operation section for details.



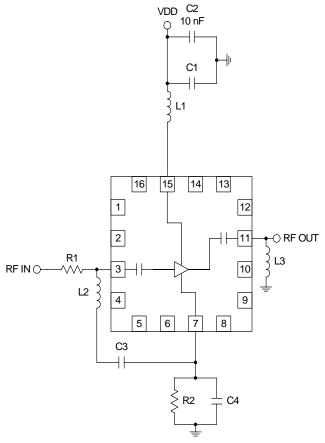
Application Schematic 800 MHz to 2200 MHz



FREQ	VCC	NF	GAIN	OIP3	OP1dB
MHz	Volts	dB	dB	dBm	dBm
800	5	1.3	16	36	22
2200	5	0.9	13.9	36	22



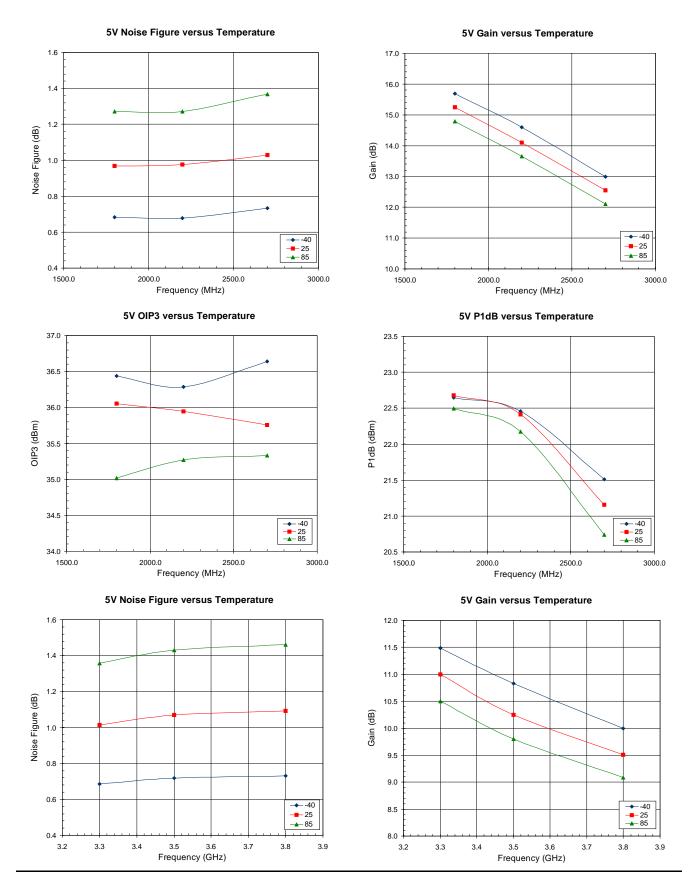
Evaluation Board Schematic 700 MHz to 3800 MHz



Components	700-1100 MHz	1.5-2.7 GHz	3.3-3.8 GHz
C1 (pF)	10	10	10
C3 (pF)	100	100	100
C4 (pF)	10	DNP	DNP
L1 (nH)	39	3.9	2.2
L2 (nH)	18	4.7	4.7
R1 (ohm)	0	0	0
R2 (ohm)	DNP	DNP	DNP
L3 (nH)	DNP	DNP	DNP

R2 is DNP for standard 90 mA current draw. If R2 is added, the I_DD will increase. A 20 Ω R2 will raise the current to achieve higher linearity.

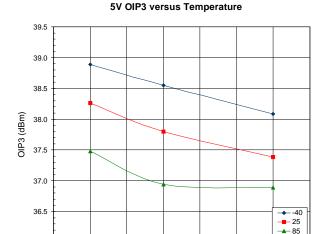




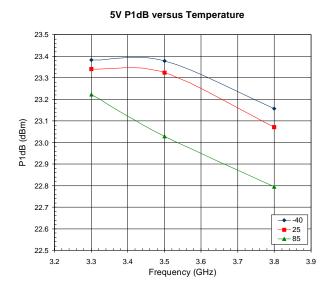
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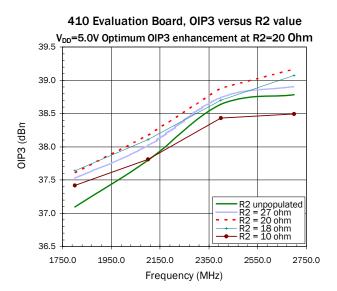
36.0

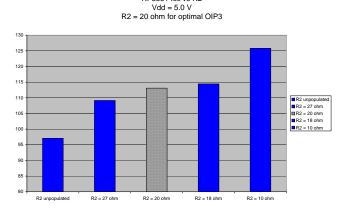




Frequency (GHz)







RF3861 Icc vs R2



Theory of Operation

Low noise figure/high IP3 make RF3861 ideal for use as both receive LNA and transmit driver for cellular/DCS/PCS/UMTS and WiMax platforms, in addition to many other general purpose applications. Standard evaluation boards cover 700 MHz to 1100 MHz, 1500 MHz to 2700 MHz, and 3300 MHz to 3800 MHz. Viewing the data sheet evaluation board schematic, refer to below for purpose/function of external components:

- R1/L3 (0Ω/unpopulated on standard evaluation boards): These unused components were placed for convenience and flexibility when needed to optimize matching for an out of band application.
- · L2/C3/C4: Placed to optimize input match, and enhance out of band low frequency stability.
- R2: Optionally placed to increase bias current and IP3. It has been found that 20Ω value is best case (see graph section
 of data sheet).
- L1/C1: Influence output return loss.

RF3861 has internal DC blocking capacitors at RFin/RFout. In addition, it has been shown impedance seen looking out at pins 7/15 influence response. As a result, two port s-parameters become non-applicable. In the event matching is desired for frequency bands outside of those provided with standard evaluation boards, the following approach can be used:

- Start with matching seen for standard evaluation board closest to desired band of operation.
- Optimize values at L2/C4/L1 to obtain response/performance.

The application schematic section of data sheet shows matching arrived at using above procedure, for 400 MHz to 1300 MHz and 800 MHz to 2200 MHz. These schematics, along with standard evaluation boards, cover 82% of the useable bandwidth from 400 MHz to 3800 MHz.

One interesting note concerning these application schematics, the 400MHz to 1300MHz example shows same component values as seen with 700MHz to 1100MHz evaluation board. So, it is, in actuality, the same board. The specification chart next to the schematic simply extends the frequency band by 500MHz. Input and output return losses are better than 10dB over the entire 900MHz bandwidth.



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